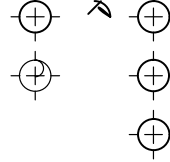


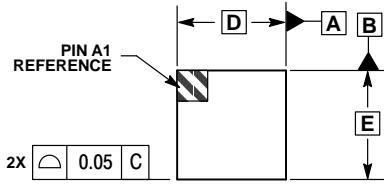
0.40
PITCH



PITCH

WLCSP9, 1.22x1.22
CASE 499BM-01
ISSUE O

DATE 27 SEP 2010

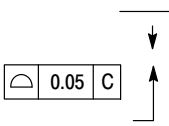


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. COPLANARITY APPLIES TO SPHERICAL CROWNS OF SOLDER BALLS.

DIM	MILLIMETERS	
	MIN	MAX
A	---	0.66
A1		

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DESCRIPTION:		



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**SEATING
PLANE**

